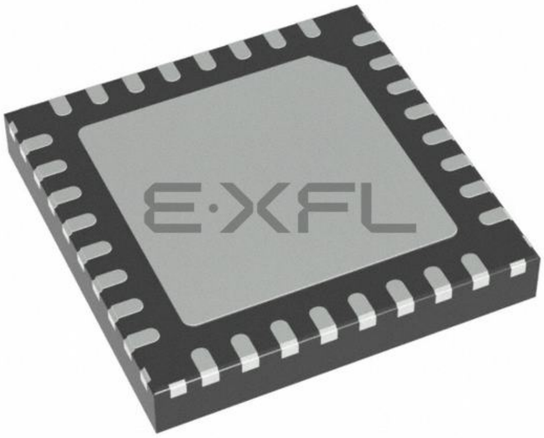

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M0+
Core Size	32-Bit Single-Core
Speed	48MHz
Connectivity	I²C, LINbus SBC, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, PWM, WDT
Number of I/O	19
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	0V ~ 3.8V
Data Converters	A/D 6x12b; D/A 1x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TC)
Mounting Type	Surface Mount, Wettable Flank
Package / Case	32-VFQFN Exposed Pad
Supplier Device Package	32-VQFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atsamha1e15a-mbt-bvao

15. DSU - Device Service Unit

15.1 Overview

The Device Service Unit (DSU) provides a means of detecting debugger probes. It enables the ARM Debug Access Port (DAP) to have control over multiplexed debug pads and CPU reset. The DSU also provides system-level services to debug adapters in an ARM debug system. It implements a CoreSight Debug ROM that provides device identification as well as identification of other debug components within the system. Hence, it complies with the ARM Peripheral Identification specification. The DSU also provides system services to applications that need memory testing, as required for IEC60730 Class B compliance, for example. The DSU can be accessed simultaneously by a debugger and the CPU, as it is connected on the High-Speed Bus Matrix. For security reasons, some of the DSU features will be limited or unavailable when the device is protected by the NVMCTRL security bit.

Related Links

System Services Availability when Accessed Externally and Device is Protected
NVMCTRL – Nonvolatile Memory Controller
Security Bit

15.2 Features

- CPU reset extension
- Debugger probe detection (Cold- and Hot-Plugging)
- Chip-Erase command and status
- 32-bit cyclic redundancy check (CRC32) of any memory accessible through the bus matrix
- ARM® CoreSight™ compliant device identification
- Two debug communications channels
- Debug access port security filter
- Onboard memory built-in self-test (MBIST)

15.13.5 Length

Name: LENGTH
Offset: 0x0008
Reset: 0x00000000
Property: PAC Write-Protection

Bit	31	30	29	28	27	26	25	24
	LENGTH[29:22]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	23	22	21	20	19	18	17	16
	LENGTH[21:14]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

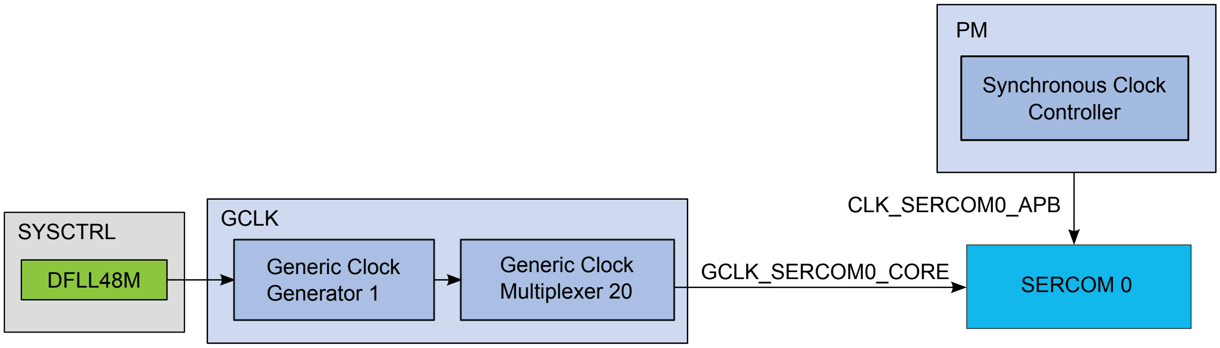
Bit	15	14	13	12	11	10	9	8
	LENGTH[13:6]							
Access	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
Reset	0	0	0	0	0	0	0	0

Bit	7	6	5	4	3	2	1	0
	LENGTH[5:0]							
Access	R/W	R/W	R/W	R/W	R/W	R/W		
Reset	0	0	0	0	0	0		

Bits 31:2 – LENGTH[29:0] Length
Length in words needed for memory operations.

SERCOM0. The SERCOM0 interface, clocked by CLK_SERCOM0_APB, has been unmasked in the APBC Mask register in the PM.

Figure 16-2. Example of SERCOM clock



16.2 Synchronous and Asynchronous Clocks

As the CPU and the peripherals can be in different clock domains, i.e. they are clocked from different clock sources and/or with different clock speeds, some peripheral accesses by the CPU need to be synchronized. In this case the peripheral includes a SYNCBUSY status register that can be used to check if a sync operation is in progress.

For a general description, see Register Synchronization. Some peripherals have specific properties described in their individual sub-chapter “Synchronization”.

In the datasheet, references to Synchronous Clocks are referring to the CPU and bus clocks, while asynchronous clocks are generated by the Generic Clock Controller (GCLK).

16.3 Register Synchronization

There are two different register synchronization schemes implemented on this device: *common synchronizer register synchronization* and *distributed synchronizer register synchronization*.

The modules using a common synchronizer register synchronization are: GCLK, WDT, RTC, EIC, TC, ADC, AC and DAC.

The modules adopting a distributed synchronizer register synchronization are: SERCOM USART, SERCOM SPI, SERCOM I2C.

16.3.1 Common Synchronizer Register Synchronization

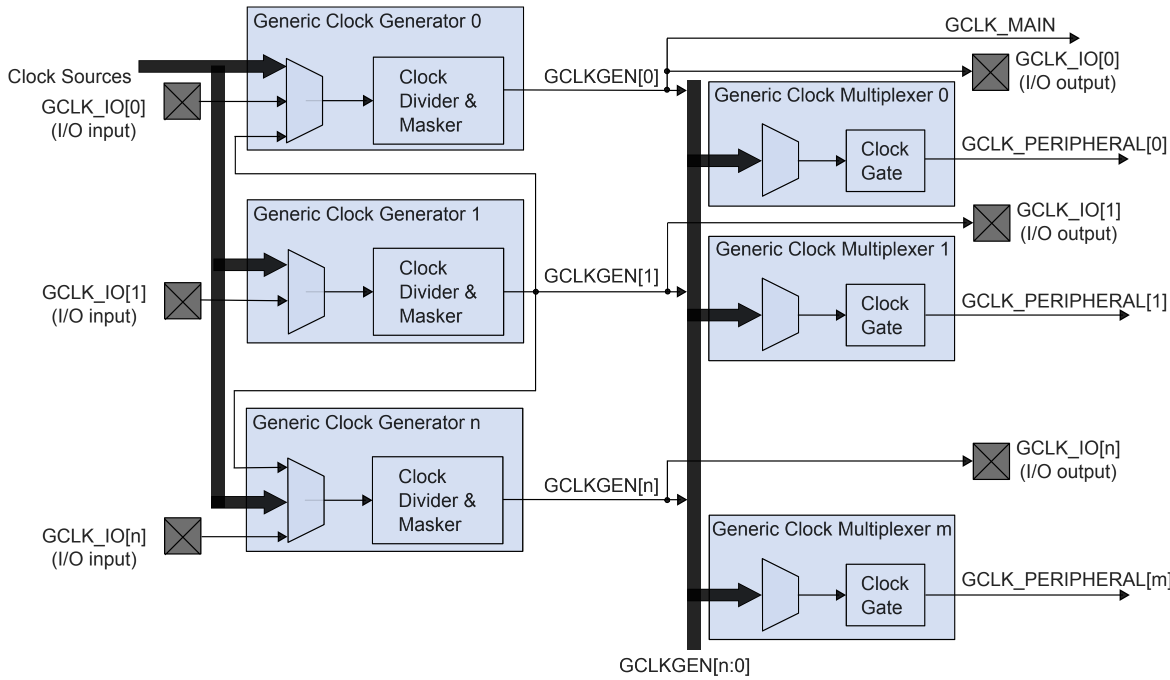
16.3.1.1 Overview

All peripherals are composed of one digital bus interface connected to the APB or AHB bus and running from a corresponding clock in the Main Clock domain, and one peripheral core running from the peripheral Generic Clock (GCLK).

Communication between these clock domains must be synchronized. This mechanism is implemented in hardware, so the synchronization process takes place even if the peripheral generic clock is running from the same clock source and on the same frequency as the bus interface.

All registers in the bus interface are accessible without synchronization. All registers in the peripheral core are synchronized when written. Some registers in the peripheral core are synchronized when read.

Figure 17-2. Generic Clock Controller Block Diagram(1)



Note: 1. If GENCTRL.SRC=0x01(GCLKIN), the GCLK_IO is set as an input.

17.4 Signal Description

Table 17-1. Signal Description

Signal Name	Type	Description
GCLK_IO[7:0]	Digital I/O	Clock source for Generators when input Generic Clock signal when output

Refer to PORT Function Multiplexing table in I/O Multiplexing and Considerations for details on the pin mapping for this peripheral.

Note: One signal can be mapped on several pins.

Related Links

I/O Multiplexing and Considerations

17.5 Product Dependencies

In order to use this peripheral, other parts of the system must be configured correctly, as described below.

17.5.1 I/O Lines

Using the GCLK I/O lines requires the I/O pins to be configured.

Related Links

PORT - I/O Pin Controller

18.8.3 CPU Clock Select

Name: CPUSEL
Offset: 0x08
Reset: 0x00
Property: Write-Protected

Bit	7	6	5	4	3	2	1	0
						CPUDIV[2:0]		
Access						R/W	R/W	R/W
Reset						0	0	0

Bits 2:0 – CPUDIV[2:0] CPU Prescaler Selection
These bits define the division ratio of the main clock prescaler (2^n).

CPUDIV[2:0]	Name	Description
0x0	DIV1	Divide by 1
0x1	DIV2	Divide by 2
0x2	DIV4	Divide by 4
0x3	DIV8	Divide by 8
0x4	DIV16	Divide by 16
0x5	DIV32	Divide by 32
0x6	DIV64	Divide by 64
0x7	DIV128	Divide by 128

The oscillator is disabled by writing a zero to the Enable bit (XOSC32K.ENABLE) in the 32kHz External Crystal Oscillator Control register while keeping the other bits unchanged. Writing to the XOSC32K.ENABLE bit while writing to other bits may result in unpredictable behavior. The oscillator remains enabled in all sleep modes if it has been enabled beforehand. The start-up time of the 32kHz External Crystal Oscillator is selected by writing to the Oscillator Start-Up Time bit group (XOSC32K.STARTUP) in the in the 32kHz External Crystal Oscillator Control register. The SYSCTRL masks the oscillator output during the start-up time to ensure that no unstable clock propagates to the digital logic. The 32kHz External Crystal Oscillator Ready bit (PCLKSR.XOSC32KRDY) in the Power and Clock Status register is set when the user-selected startup time is over. An interrupt is generated on a zero-to-one transition of PCLKSR.XOSC32KRDY if the 32kHz External Crystal Oscillator Ready bit (INTENSET.XOSC32KRDY) in the Interrupt Enable Set Register is set.

As a crystal oscillator usually requires a very long start-up time (up to one second), the 32kHz External Crystal Oscillator will keep running across resets, except for power-on reset (POR).

XOSC32K can provide two clock outputs when connected to a crystal. The XOSC32K has a 32.768kHz output enabled by writing a one to the 32kHz External Crystal Oscillator 32kHz Output Enable bit (XOSC32K.EN32K) in the 32kHz External Crystal Oscillator Control register. XOSC32K.EN32K is only usable when XIN32 is connected to a crystal, and not when an external digital clock is applied on XIN32.

Note: Do not enter standby mode when an oscillator is in start-up:
Wait for the OSCxRDY bit in SYSCTRL.PCLKSR register to be set before going into standby mode.

Related Links

GCLK - Generic Clock Controller

19.6.4 32kHz Internal Oscillator (OSC32K) Operation

The OSC32K provides a tunable, low-speed and low-power clock source.

The OSC32K can be used as a source for the generic clock generators, as described in the *GCLK – Generic Clock Controller*.

The OSC32K is disabled by default. The OSC32K is enabled by writing a one to the 32kHz Internal Oscillator Enable bit (OSC32K.ENABLE) in the 32kHz Internal Oscillator Control register. It is disabled by writing a zero to OSC32K.ENABLE. The OSC32K has a 32.768kHz output enabled by writing a one to the 32kHz Internal Oscillator 32kHz Output Enable bit (OSC32K.EN32K).

The frequency of the OSC32K oscillator is controlled by the value in the 32kHz Internal Oscillator Calibration bits (OSC32K.CALIB) in the 32kHz Internal Oscillator Control register. The OSC32K.CALIB value must be written by the user. Flash Factory Calibration values are stored in the NVM Software Calibration Area (refer to *NVM Software Calibration Area Mapping*). When writing to the Calibration bits, the user must wait for the PCLKSR.OSC32KRDY bit to go high before the value is committed to the oscillator.

Related Links

GCLK - Generic Clock Controller
NVM Software Calibration Area Mapping

19.6.5 32kHz Ultra Low Power Internal Oscillator (OSCULP32K) Operation

The OSCULP32K provides a tunable, low-speed and ultra-low-power clock source. The OSCULP32K is factory-calibrated under typical voltage and temperature conditions. The OSCULP32K should be preferred to the OSC32K whenever the power requirements are prevalent over frequency stability and accuracy.

The XOSC source can be divided inside the FDPLL96M. The user must make sure that the programmable clock divider and XOSC frequency provides a valid CLK_FDPLL96M_REF clock frequency that meets the FDPLL96M input frequency range.

The output clock of the FDPLL96M is CLK_FDPLL96M. The state of the CLK_FDPLL96M clock only depends on the FDPLL96M internal control of the final clock gater CG.

The FDPLL96M requires a 32kHz clock from the GCLK when the FDPLL96M internal lock timer is used. This clock must be configured and enabled in the Generic Clock Controller before using the FDPLL96M. Refer to *GCLK – Generic Clock Controller* for details.

Table 19-3. Generic Clock Input for FDPLL96M

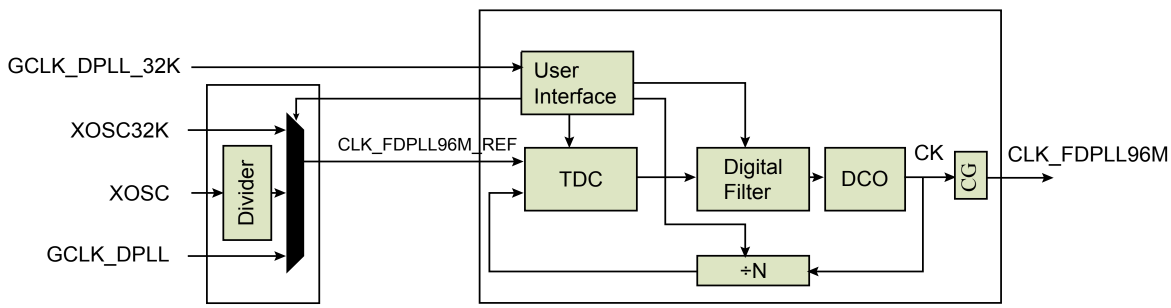
Generic Clock	FDPLL96M
FDPLL96M 32kHz clock	GCLK_DPLL_32K for internal lock timer
FDPLL96M	GCLK_DPLL for CLK_FDPLL96M_REF

Related Links

GCLK - Generic Clock Controller

19.6.8.2 Block Diagram

Figure 19-2. FDPLL96M Block Diagram



19.6.8.3 Principle of Operation

The task of the FDPLL96M is to maintain coherence between the input reference clock signal (CLK_FDPLL96M_REF) and the respective output frequency CK via phase comparison. The FDPLL96M supports three independent sources of clocks; XOSC32K, XOSC and GCLK_DPLL. When the FDPLL96M is enabled, the relationship between the reference clock (CLK_FDPLL96M_REF) frequency and the output clock (CLK_FDPLL96M) frequency is defined below.

$$f_{clk\_fdpll96m} = f_{clk\_fdpll96m\_ref} \times \left(LDR + 1 + \frac{LDRFRAC}{16}\right)$$

Where LDR is the loop divider ratio integer part, LDRFRAC is the loop divider ratio fractional part, f_{ckrx} is the frequency of the selected reference clock and f_{ck} is the frequency of the FDPLL96M output clock. As previously stated a clock divider exist between XOSC and CLK_FDPLL96M_REF. The frequency between the two clocks is defined below.

$$f_{clk\_fdpll96m\_ref} = f_{xosc} \times \left(\frac{1}{2 \times (DIV + 1)}\right)$$

When the FDPLL96M is disabled, the output clock is reset. If the loop divider ratio fractional part (DPLLRATIO.LDRFRAC) field is reset, the FDPLL96M works in integer mode, otherwise the fractional

TRIGACT[1:0]	Name	Description
0x2	BEAT	One trigger required for each beat transfer
0x3	TRANSACTION	One trigger required for each transaction

Bits 13:8 – TRIGSRC[5:0] Trigger Source
These bits define the peripheral trigger which is source of the transfer. For details on trigger selection and trigger modes, refer to Transfer Triggers and Actions and CHCTRLB.TRIGACT.

Value	Name	Description
0x00	DISABLE	Only software/event triggers
0x01	SERCOM0 RX	SERCOM0 RX Trigger
0x02	SERCOM0 TX	SERCOM0 TX Trigger
0x03	SERCOM1 RX	SERCOM1 RX Trigger
0x04	SERCOM1 TX	SERCOM1 TX Trigger
0x05	SERCOM2 RX	SERCOM2 RX Trigger
0x06	SERCOM2 TX	SERCOM2 TX Trigger
0x07	SERCOM3 RX	SERCOM3 RX Trigger
0x08	SERCOM3 TX	SERCOM3 TX Trigger
0x09	SERCOM4 RX	SERCOM4 RX Trigger
0x0A	SERCOM4 TX	SERCOM4 TX Trigger
0x0B	TCC0 OVF	TCC0 Overflow Trigger
0x0C	TCC0 MC0	TCC0 Match/Compare 0 Trigger
0x0D	TCC0 MC1	TCC0 Match/Compare 1 Trigger
0x0E	TCC0 MC2	TCC0 Match/Compare 2 Trigger
0x0F	TCC0 MC3	TCC0 Match/Compare 3 Trigger
0x10	TCC1 OVF	TCC1 Overflow Trigger
0x11	TCC1 MC0	TCC1 Match/Compare 0 Trigger
0x12	TCC1 MC1	TCC1 Match/Compare 1 Trigger
0x13	TCC2 OVF	TCC2 Overflow Trigger
0x14	TCC2 MC0	TCC2 Match/Compare 0 Trigger
0x15	TCC2 MC1	TCC2 Match/Compare 1 Trigger
0x16	TC0 OVF	TC0 Overflow Trigger
0x17	TC0 MC0	TC0 Match/Compare 0 Trigger
0x18	TC0 MC1	TC0 Match/Compare 1 Trigger
0x19	TC1 OVF	TC1 Overflow Trigger
0x1A	TC1 MC0	TC1 Match/Compare 0 Trigger
0x1B	TC1 MC1	TC1 Match/Compare 1 Trigger
0x1C	TC2 OVF	TC2 Overflow Trigger
0x1D	TC2 MC0	TC2 Match/Compare 0 Trigger
0x1E	TC2 MC1	TC2 Match/Compare 1 Trigger
0x1F	TC3 OVF	TC3 Overflow Trigger
0x20	TC3 MC0	TC3 Match/Compare 0 Trigger
0x21	TC3 MC1	TC3 Match/Compare 1 Trigger
0x22	TC4 OVF	TC4 Overflow Trigger
0x23	TC4 MC0	TC4 Match/Compare 0 Trigger
0x24	TC4 MC1	TC4 Match/Compare 1 Trigger
0x25	ADC RESRDY	ADC Result Ready Trigger

25.9.2 Data Direction Clear

Name: DIRCLR
Offset: 0x04
Reset: 0x00000000
Property: PAC Write-Protection

This register allows the user to set one or more I/O pins as an input, without doing a read-modify-write operation. Changes in this register will also be reflected in the Data Direction (DIR), Data Direction Toggle (DIRTGL) and Data Direction Set (DIRSET) registers.

Tip: The I/O pins are assembled in pin groups (”PORT groups”) with up to 32 pins. Group 0 consists of the PA pins, group 1 is for the PB pins, etc. Each pin group has its own PORT registers, with a 0x80 address spacing. For example, the register address offset for the Data Direction (DIR) register for group 0 (PA00 to PA31) is 0x00, and the register address offset for the DIR register for group 1 (PB00 to PB31) is 0x80.

Bit	31	30	29	28	27	26	25	24
	DIRCLR[31:24]							
Access	RW	RW	RW	RW	RW	RW	RW	RW
Reset	0	0	0	0	0	0	0	0

Bit	23	22	21	20	19	18	17	16
	DIRCLR[23:16]							
Access	RW	RW	RW	RW	RW	RW	RW	RW
Reset	0	0	0	0	0	0	0	0

Bit	15	14	13	12	11	10	9	8
	DIRCLR[15:8]							
Access	RW	RW	RW	RW	RW	RW	RW	RW
Reset	0	0	0	0	0	0	0	0

Bit	7	6	5	4	3	2	1	0
	DIRCLR[7:0]							
Access	RW	RW	RW	RW	RW	RW	RW	RW
Reset	0	0	0	0	0	0	0	0

Bits 31:0 – DIRCLR[31:0] Port Data Direction Clear
Writing a '0' to a bit has no effect.

Writing a '1' to a bit will clear the corresponding bit in the DIR register, which configures the I/O pin as an input.

Value	Description
0	The corresponding I/O pin in the PORT group will keep its configuration.
1	The corresponding I/O pin in the PORT group is configured as input.

PATH[1:0]	Name	Description
0x0	SYNCHRONOUS	Synchronous path
0x1	RESYNCHRONIZED	Resynchronized path
0x2	ASYNCHRONOUS	Asynchronous path
0x3		Reserved

Bits 22:16 – EVGEN[6:0] Event Generator Selection
These bits are used to choose which event generator to connect to the selected channel.

Value	Event Generator	Description
0x00	NONE	No event generator selected
0x01	RTC CMP0	Compare 0 (mode 0 and 1) or Alarm 0 (mode 2)
0x02	RTC CMP1	Compare 1
0x03	RTC OVF	Overflow
0x04	RTC PER0	Period 0
0x05	RTC PER1	Period 1
0x06	RTC PER2	Period 2
0x07	RTC PER3	Period 3
0x08	RTC PER4	Period 4
0x09	RTC PER5	Period 5
0x0A	RTC PER6	Period 6
0x0B	RTC PER7	Period 7
0x0C	EIC EXTINT0	
0x0D	EIC EXTINT1	External Interrupt 1
0x0E	EIC EXTINT2	External Interrupt 2
0x0F	EIC EXTINT3	External Interrupt 3
0x10	EIC EXTINT4	External Interrupt 4
0x11	EIC EXTINT5	External Interrupt 5
0x12	EIC EXTINT6	External Interrupt 6
0x13	EIC EXTINT7	External Interrupt 7
0x14	EIC EXTINT8	External Interrupt 8
0x15	EIC EXTINT9	External Interrupt 9
0x16	EIC EXTINT10	External Interrupt 10
0x17	EIC EXTINT11	External Interrupt 11

Value	Description
0	SWRST synchronization is not busy.
1	SWRST synchronization is busy.

30.7 Register Summary - I2C Slave

Offset	Name	Bit Pos.								
0x00	CTRLA	7:0	RUNSTDBY			MODE[2:0]			ENABLE	SWRST
		15:8								
		23:16	SEXTTOEN		SDAHOLD[1:0]					PINOUT
		31:24		LOWTOUT			SCLSM		SPEED[1:0]	
0x04	CTRLB	7:0								
		15:8	AMODE[1:0]					AACKEN	GCMD	SMEN
		23:16						ACKACT	CMD[1:0]	
		31:24								
0x08 ... 0x13	Reserved									
0x14	INTENCLR	7:0	ERROR					DRDY	AMATCH	PREC
0x15	Reserved									
0x16	INTENSET	7:0	ERROR					DRDY	AMATCH	PREC
0x17	Reserved									
0x18	INTFLAG	7:0	ERROR					DRDY	AMATCH	PREC
0x19	Reserved									
0x1A	STATUS	7:0	CLKHOLD	LOWTOUT		SR	DIR	RXNACK	COLL	BUSERR
		15:8					LENERR	HS	SEXTTOUT	
0x1C	SYNCBUSY	7:0							ENABLE	SWRST
		15:8								
		23:16								
		31:24								
0x20 ... 0x23	Reserved									
0x24	ADDR	7:0	ADDR[6:0]							GENCEN
		15:8	TENBITEN					ADDR[9:7]		
		23:16	ADDRMASK[6:0]							
		31:24						ADDRMASK[9:7]		
0x28	DATA	7:0	DATA[7:0]							
		15:8								

30.8 Register Description - I^{2}C Slave

Registers can be 8, 16, or 32 bits wide. Atomic 8-, 16- and 32-bit accesses are supported. In addition, the 8-bit quarters and 16-bit halves of a 32-bit register, and the 8-bit halves of a 16-bit register can be accessed directly.

Some registers are optionally write-protected by the Peripheral Access Controller (PAC). Optional PAC write-protection is denoted by the "PAC Write-Protection" property in each individual register description. For details, refer to Register Access Protection.

30.10.7 Status

Name: STATUS
Offset: 0x1A
Reset: 0x0000
Property: Write-Synchronized

Bit	15	14	13	12	11	10	9	8
						LENERR	SEXTTOUT	MEXTTOUT
Access						R/W	R/W	R/W
Reset						0	0	0

Bit	7	6	5	4	3	2	1	0
	CLKHOLD	LOWTOUT	BUSSTATE[1:0]			RXNACK	ARBLOST	BUSERR
Access	R	R/W	R/W	R/W		R	R/W	R/W
Reset	0	0	0	0		0	0	0

Bit 10 – LENERR Transaction Length Error
This bit is set when automatic length is used for a DMA transaction and the slave sends a NACK before ADDR.LEN bytes have been written by the master.

Writing '1' to this bit location will clear STATUS.LENERR. This flag is automatically cleared when writing to the ADDR register.

Writing '0' to this bit has no effect.

This bit is not write-synchronized.

Bit 9 – SEXTTOUT Slave SCL Low Extend Time-Out
This bit is set if a slave SCL low extend time-out occurs.

This bit is automatically cleared when writing to the ADDR register.

Writing '1' to this bit location will clear SEXTTOUT. Normal use of the I^2C interface does not require the SEXTTOUT flag to be cleared by this method.

Writing '0' to this bit has no effect.

This bit is not write-synchronized.

Bit 8 – MEXTTOUT Master SCL Low Extend Time-Out
This bit is set if a master SCL low time-out occurs.

Writing '1' to this bit location will clear STATUS.MEXTTOUT. This flag is automatically cleared when writing to the ADDR register.

Writing '0' to this bit has no effect.

This bit is not write-synchronized.

Bit 7 – CLKHOLD Clock Hold
This bit is set when the master is holding the SCL line low, stretching the I^2C clock. Software should consider this bit when INTFLAG.SB or INTFLAG.MB is set.

1. Enable the TCC bus clock (CLK_TCCx_APB).
2. If Capture mode is required, enable the channel in capture mode by writing a '1' to the Capture Enable bit in the Control A register (CTRLA.CPTEN).

Optionally, the following configurations can be set before enabling TCC:

1. Select PRESCALER setting in the Control A register (CTRLA.PRESCALER).
2. Select Prescaler Synchronization setting in Control A register (CTRLA.PRESCSYNC).
3. If down-counting operation is desired, write the Counter Direction bit in the Control B Set register (CTRLBSET.DIR) to '1'.
4. Select the Waveform Generation operation in the WAVE register (WAVE.WAVEGEN).
5. Select the Waveform Output Polarity in the WAVE register (WAVE.POL).
6. The waveform output can be inverted for the individual channels using the Waveform Output Invert Enable bit group in the Driver register (DRVCTRL.INVEN).

32.6.2.2 Enabling, Disabling, and Resetting

The TCC is enabled by writing a '1' to the Enable bit in the Control A register (CTRLA.ENABLE). The TCC is disabled by writing a zero to CTRLA.ENABLE.

The TCC is reset by writing '1' to the Software Reset bit in the Control A register (CTRLA.SWRST). All registers in the TCC, except DBGCTRL, will be reset to their initial state, and the TCC will be disabled. Refer to Control A (CTRLA) register for details.

The TCC should be disabled before the TCC is reset to avoid undefined behavior.

32.6.2.3 Prescaler Selection

The GCLK_TCCx clock is fed into the internal prescaler.

The prescaler consists of a counter that counts up to the selected prescaler value, whereupon the output of the prescaler toggles.

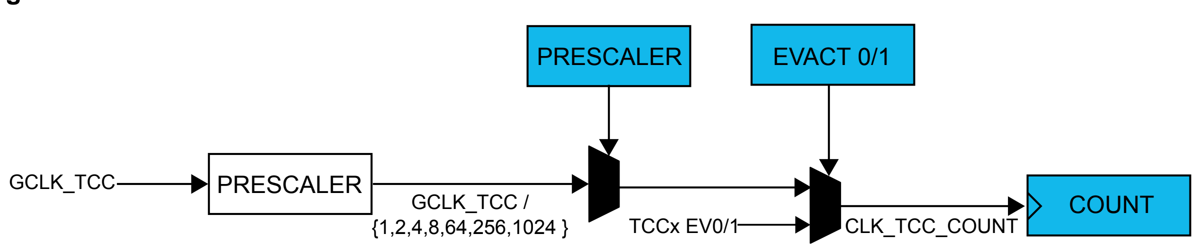
If the prescaler value is higher than one, the counter update condition can be optionally executed on the next GCLK_TCC clock pulse or the next prescaled clock pulse. For further details, refer to the Prescaler (CTRLA.PRESCALER) and Counter Synchronization (CTRLA.PRESYNC) descriptions.

Prescaler outputs from 1 to 1/1024 are available. For a complete list of available prescaler outputs, see the register description for the Prescaler bit group in the Control A register (CTRLA.PRESCALER).

Note: When counting events, the prescaler is bypassed.

The joint stream of prescaler ticks and event action ticks is called CLK_TCC_COUNT.

Figure 32-2. Prescaler



32.6.2.4 Counter Operation

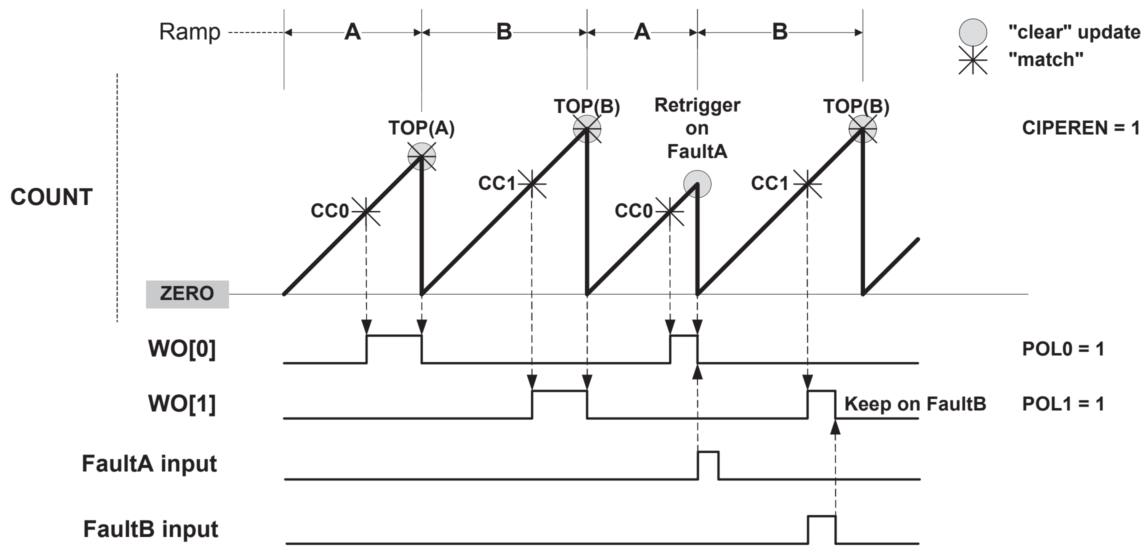
Depending on the mode of operation, the counter is cleared, reloaded, incremented, or decremented at each TCC clock input (CLK_TCC_COUNT). A counter clear or reload mark the end of current counter cycle and the start of a new one.

RAMP1 Operation
This is the default PWM operation, described in Single-Slope PWM Generation.

RAMP2 Operation
These operation modes are dedicated for power factor correction (PFC), Half-Bridge and Push-Pull SMPS topologies, where two consecutive timer/counter cycles are interleaved, see Figure 32-18. In cycle A, odd channel output is disabled, and in cycle B, even channel output is disabled. The ramp index changes after each update, but can be software modified using the Ramp index command bits in Control B Set register (CTRLBSET.IDXCMD).

Standard RAMP2 (RAMP2) Operation
Ramp A and B periods are controlled by the PER register value. The PER value can be different on each ramp by the Circular Period buffer option in the Wave register (WAVE.CIPEREN=1). This mode uses a two-channel TCC to generate two output signals, or one output signal with another CC channel enabled in capture mode.

Figure 32-18. RAMP2 Standard Operation



Alternate RAMP2 (RAMP2A) Operation
Alternate RAMP2 operation is similar to RAMP2, but CC0 controls both WO[0] and WO[1] waveforms when the corresponding circular buffer option is enabled (CIPEREN=1). The waveform polarity is the same on both outputs. Channel 1 can be used in capture mode.

32.8.8 Debug control

Name: DBGCTRL
Offset: 0x1E
Reset: 0x00
Property: PAC Write-Protection

Bit	7	6	5	4	3	2	1	0
						FDDBD		DBGRUN
Access						R/W		R/W
Reset						0		0

Bit 2 – FDDBD Fault Detection on Debug Break Detection
This bit is not affected by software reset and should not be changed by software while the TCC is enabled.

By default this bit is zero, and the on-chip debug (OCD) fault protection is disabled. When this bit is written to '1', OCD break request from the OCD system will trigger non-recoverable fault. When this bit is set, OCD fault protection is enabled and OCD break request from the OCD system will trigger a non-recoverable fault.

Value	Description
0	No faults are generated when TCC is halted in debug mode.
1	A non recoverable fault is generated and FAULTD flag is set when TCC is halted in debug mode.

Bit 0 – DBGRUN Debug Running State
This bit is not affected by software reset and should not be changed by software while the TCC is enabled.

Value	Description
0	The TCC is halted when the device is halted in debug mode.
1	The TCC continues normal operation when the device is halted in debug mode.

Value	Name
0	Hysteresis is disabled.
1	Hysteresis is enabled.

Bits 17:16 – OUT[1:0] Output
These bits configure the output selection for comparator n. COMPCTRLn.OUT can be written only while COMPCTRLn.ENABLE is zero.

These bits are not synchronized.

Value	Name	Description
0x0	OFF	The output of COMPn is not routed to the COMPn I/O port
0x1	ASYNC	The asynchronous output of COMPn is routed to the COMPn I/O port
0x2	SYNC	The synchronous output (including filtering) of COMPn is routed to the COMPn I/O port
0x3	N/A	Reserved

Bit 15 – SWAP Swap Inputs and Invert
This bit swaps the positive and negative inputs to COMPn and inverts the output. This function can be used for offset cancellation. COMPCTRLn.SWAP can be written only while COMPCTRLn.ENABLE is zero.

These bits are not synchronized.

Value	Description
0	The output of MUXPOS connects to the positive input, and the output of MUXNEG connects to the negative input.
1	The output of MUXNEG connects to the positive input, and the output of MUXPOS connects to the negative input.

Bits 13:12 – MUXPOS[1:0] Positive Input Mux Selection
These bits select which input will be connected to the positive input of comparator n. COMPCTRLn.MUXPOS can be written only while COMPCTRLn.ENABLE is zero.

These bits are not synchronized.

Value	Name	Description
0x0	PIN0	I/O pin 0
0x1	PIN1	I/O pin 1
0x2	PIN2	I/O pin 2
0x3	PIN3	I/O pin 3

Bits 10:8 – MUXNEG[2:0] Negative Input Mux Selection
These bits select which input will be connected to the negative input of comparator n. COMPCTRLn.MUXNEG can only be written while COMPCTRLn.ENABLE is zero.

These bits are not synchronized.

Value	Name	Description
0x0	PIN0	I/O pin 0
0x1	PIN1	I/O pin 1
0x2	PIN2	I/O pin 2
0x3	PIN3	I/O pin 3

No.	Parameters	Test Conditions	Pin	Symbol	Min.	Typ.	Max.	Unit	Type*
		Switch from unpowered to fail-safe mode	VS	$V_{VS\_th\_U\_F\_up}$	2.0	2.25	2.4	V	A
1.10	VS undervoltage hysteresis		VS	$V_{VS\_hys\_U}$	0.1	0.2	0.3	V	A
3	TXD input/output pin (only SBC)								
3.1	Low-level voltage input		TXD	V_{TXDL}	-0.3		+0.8	V	A
3.2	High-level voltage input		TXD	V_{TXDH}	2		V_{CC} + 0.3V	V	A
3.3	Pull-up resistor	V_{TXD} = 0V	TXD	R_{TXD}	40	70	100	kΩ	A
3.4	High-level leakage current	V_{TXD} = V_{CC}	TXD	I_{TXD}	-3		+3	µA	A
4	EN input pin (only SBC)								
4.1	Low-level voltage input		EN	V_{ENL}	-0.3		+0.8	V	A
4.2	High-level voltage input		EN	V_{ENH}	2		V_{CC} + 0.3V	V	A
4.3	Pull-down resistor	V_{EN} = VCC	EN	R_{EN}	50	125	200	kΩ	A
4.4	Low-level input current	V_{EN} = 0V	EN	I_{EN}	-3		+3	µA	A
5	NRES open drain output pin								
5.1	Low-level output voltage	V_S ≥5.5V I_{NRES} = 2mA	NRES	V_{NRESL}		0.2	0.4	V	A
5.2	Undervoltage reset time	V_{VS} ≥5.5V C_{NRES} = 20pF	NRES	t_{Reset}	2	4	6	ms	A
5.3	Reset debounce time for falling edge	V_{VS} ≥5.5V C_{NRES} = 20pF	NRES	t_{res_f}	0.5		10	µs	A
5.4	Switch off leakage current	V_{NRES} = 5.5V	NRES	I_{NRES_L}	–3		+3	µA	A
8	VCC voltage regulator								
8.1	Output voltage VCC	4V < V_S < 18V (0mA to 50mA)	VCC	VCC_{nor}	3.234		3.366	V	A
		4.5V < V_S < 18V (0mA to 85mA)	VCC	VCC_{nor}	3.234		3.366	V	C
8.2	Output voltage V_{CC} at low V_S	3V < VS < 4V	VCC	VCC_{low}	V_{VS} - V_D		3.366	V	A
8.3	Regulator drop voltage	VS > 3V, I_{VCC} = –15mA	VCC	V_{D1}		100	150	mV	A
8.4	Regulator drop voltage	VS > 3V, I_{VCC} = –50mA	VCC	V_{D2}		300	500	mV	A

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Parasitic capacitor load		C_{XIN}	-	5.9	-	pF
Parasitic capacitor load		C_{XOUT}	-	3.2	-	pF

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Startup time	f = 2MHz, C_L = 20pF, XOSC.GAIN = 0, ESR = 600Ω	$t_{STARTUP}$	-	15.6K	51.0K	cycles
	f = 4MHz, C_L = 20pF, XOSC.GAIN = 1, ESR = 100Ω		-	6.3K	20.1K	
	f = 8 MHz, C_L = 20pF, XOSC.GAIN = 2, ESR = 35Ω		-	6.2K	20.3K	
	f = 16 MHz, C_L = 20pF, XOSC.GAIN = 3, ESR = 25Ω		-	7.7K	21.2K	
	f = 32MHz, C_L = 18pF, XOSC.GAIN = 4, ESR = 40Ω		-	6.0K	14.2K	

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Current Consumption	f = 2MHz, C_L = 20pF, XOSC.GAIN = 0, AGC off		-	89	190	µA
	f = 2MHz,		-	82	187	

37.15.2 SERCOM in SPI Mode Timing

Figure 37-13. SPI Timing Requirements in Master Mode

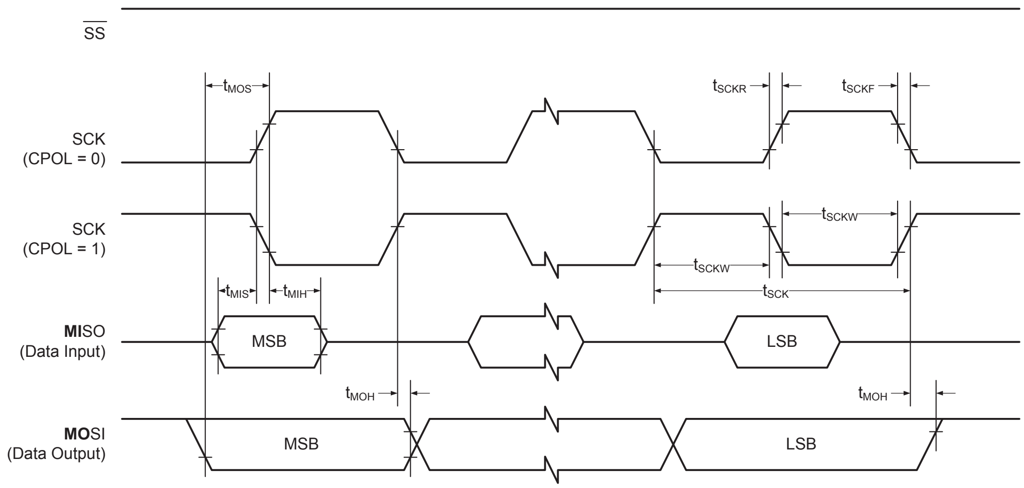


Figure 37-14. SPI Timing Requirements in Slave Mode

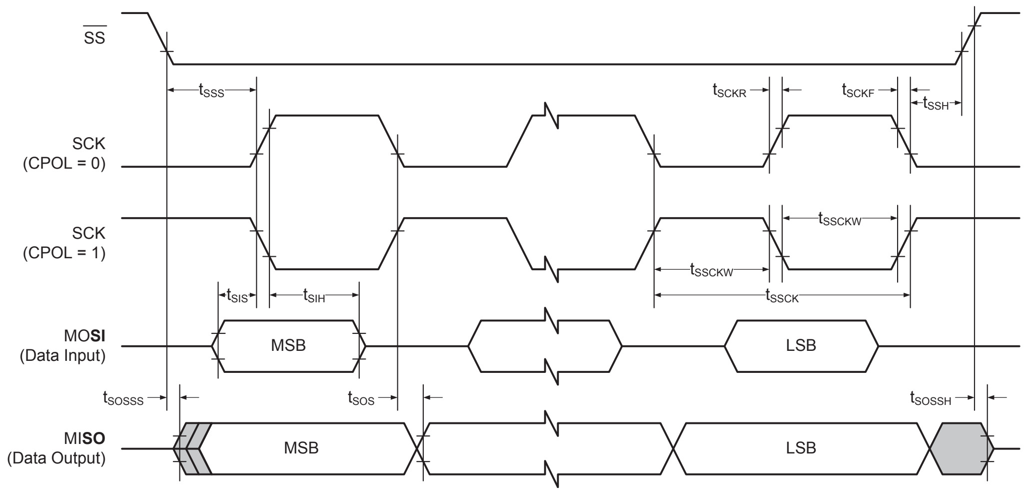


Table 37-51. SPI Timing Characteristics and Requirements(1)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
t_{SCK}	SCK period	Master		84		ns
t_{SCKW}	SCK high/low width	Master	-	$0.5*t_{SCK}$	-	
t_{SCKR}	SCK rise time(2)	Master	-	-	-	
t_{SCKF}	SCK fall time(2)	Master	-	-	-	
t_{MIS}	MISO setup to SCK	Master	-	21	-	
t_{MIH}	MISO hold after SCK	Master	-	13	-	
t_{MOS}	MOSI setup SCK	Master	-	$t_{SCK}/2 - 3$	-	
t_{MOH}	MOSI hold after SCK	Master	-	3	-	
t_{SSCK}	Slave SCK Period	Slave	$1*t_{CLK\_APB}$	-	-	